

Seagate® Nytro® XF1230 SATA SSD

Product Manual

XF1230-1A0240 XF1230-1A0480 XF1230-1A0960 XF1230-1A1920

Revision History

Version and Date	Description of Changes
Rev B, April, 2016	Updated the following:
	Cover page, model number.
	■ Section 2.1, Models and Capacity, Table 2, model number.
	Section 2.2, Performance., added Sequential Read, Sequential Write specifications. Updated Random Write 8 K specification for 480 GB.
Rev A, March 2016	First release of the document.

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When referring to drive capacity, one gigabyte, or GB, equals one billion bytes and one terabyte, or TB, equals one trillion bytes. Your computer's operating system may use a different standard of measurement and report a lower capacity. In addition, some of the listed capacity is used for formatting and other functions, and thus will not be available for data storage. Actual quantities will vary based on various factors, including file size, file format, features and application software. Actual data rates may vary depending on operating environment and other factors. The export or re-export of hardware or software containing encryption may be regulated by the U.S. Department of Commerce, Bureau of Industry and Security (for more information, visit www.bis.doc.gov), and controlled for import and use outside of the U.S. Seagate reserves the right to change, without notice, product offerings or specifications.

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Seagate Technology Support Services

For Nytro® Support, visit: http://www.seagate.com/support/by-product/ssd-and-pcie-flash/

For information regarding online support and services, visit: http://www.seagate.com/contacts/

Available services include:

- Presales & Technical support
- Global Support Services telephone numbers & business hours
- Authorized Service Centers

For information regarding Warranty Support, visit: http://www.seagate.com/support/warranty-and-replacements/

For information regarding data recovery services, visit:

http://www.seagate.com/services-software/seagate-recovery-services/recover/

For Seagate OEM and Distribution partner and Seagate reseller portal, visit: http://www.seagate.com/partners

www.Seagate.com Introduction

1. Introduction

The Seagate® Nytro® XF1230 SSDs provide high reliability and sustained performance for enterprise Server and Storage products. The Nytro XF1230 series offers SATA interface, fully compatible with SATA 3.1 6.0Gb/s.

Table 1 Nytro XF1230 Card Features

Feature	Description			
Capacity	■ 240, 480, 960, 1920 GB			
Certifications, Eco-Compliance	CE, UL, FCC, RCM, BSMI, KCC, Microsoft WHQRoHS)L, SATA-IO		
Dimension	■ (69.85±0.25) x (100±0.25) x (Max. 7) mm	SSD Outer case can support suitable Z-height for various host situations.		
Endurance	■ 1> DWPD	See Table 9, Endurance, on page 9.		
Form	■ 2.5 Inch Standard SSD			
Interface Compliance	 Fully compliant with SATA revision 3.1, comp Fully compliant with ATA-8/ACS-4 Standard. PIO, DMA, UDMA (up to 6, dependent on ho SATA 6.0Gb/s Native Command Queuing (Notes) SMART command transport (SCT) technolog Data Set Management Command Trim supp 	st) supported. CQ): up to 32 commands. gy.		
Latency	Read: 135 μs (Typ.)Write: 55 μs (Typ.)	Latency measured with transfer size 4 KB and queue depth of 1 on a random workload, and based on high density (1920 GB).		
NAND	■ 16 nm			
Performance Random (Sustained) Performance	 4 KB Read: Up to 98K IOPS 4 KB Write: Up to 17K IOPS 8 KB Read: Up to 58K IOPS 8 KB Write: Up to 8K IOPS Read: Up to 560MB/s 	Actual performance might vary depending on use conditions and environment. Typical I/O performance numbers measured with a queue depth of 32, write cache enabled, 6Gb/s SAS chipset port, and the Intel RST driver. Actual performance might vary depending on		
Sequential (128 KB Sustained)	■ Write: Up to 490MB/s	use conditions and environment. Typical I/O performance numbers as measured with a queue depth of 32, write cache enabled, 6Gb/s SAS chipset port, and the Intel RST driver.		
Power Consumption	Active: Up to 4.8 WIdle: Up to 0.7 W	RMS Average. NOTE This specification is for the 1920 GB drive; smaller capacity drive have lower active power.		
Power Loss Prote	ction			
Power Management	2.5 inch: 5 V SATA SupplyOS-aware hot plug/removal			
Power On Ready	Normal shut down: 5 sUnsolicited shut down: 21 s	Based on High Density (1920 GB).		
Quality of Service	 Read/Write: 0.2 ms / 1.4ms (99.9%) Read/Write: 0.3 ms / 21ms (99.9999%) 	Based on Random 4 KB, queue depth=1, and 1920 GB Density.		

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Table 1 Nytro XF1230 Card Features (continued)

Feature	Description
Reliability	 MTBF: 2 million hours BER: 1 error in 10¹⁷bits transferred (exponential) End-to-End data-path protection
Shock	 Operating: 1500G, duration 0.5ms Non-Operating: 1500G, duration 0.5ms
Temperature Range (Operating)	 0°C to 70°C Temperature Sensor (SMART Attribute ID 194)
Vibration	 Operating:20G, 10~2 KHz (Frequency) Non-Operating: 20G, 10~2 KHz (Frequency)
Voltage	■ 5V±5%
Warranty	 Five years limited Warranty with Media Usage, based on the shorter of term or endurance usage of the drive.
Weight	■ up to 85g ±5%

www.Seagate.com Specifications

2. Specifications

2.1 Models and Capacity

Table 2 Nytro XF1230 Card Models

Device Name	Model Names	Model Names Usable Capacity	
Nytro XF1230	XF1230-1A0240	240 GB	468,862,128
Nytro XF1230	XF1230-1A0480	480 GB	937,703,088
Nytro XF1230	XF1230-1A0960	960 GB	1,875,385,008
Nytro XF1230	XF1230-1A1920	1920 GB	3,750,748,848

2.2 Performance

Table 3 Random Read/Write Input/Output Operations Per Second (IOPS)

Parameter	240 GB	480 GB	960 GB	1920 GB
Random 4 KB Read (IOPS)	98,000	98,000	98,000	98,000
Random 4 KB Write (IOPS)	8,000	15,000	16,000	17,000
Random 8 KB Read (IOPS)	58,000	58,000	58,000	58,000
Random 8 KB Write (IOPS)	4,000	7,500	8,000	7,500
Sequential Read (Sustained)	560MB/s	560MB/s	560MB/s	560MB/s
Sequential Write (Sustained)	290MB/s	500MB/s	460MB/s	430MB/s

NOTE Performance measured with queue depth set to 32.

4 KB = 4,096 bytes, 8 KB = 8,192 bytes.

Drive write cache enabled.

Measurements performed on Full Logical Block Address (LBA) range, sustained for 2x Drive Capacity.

Set to 4 KB alignment.

Performance test precondition: Drive is preconditioned with 2x drive capacity 128 KB write IOs.

Measured on system with Intel Xeon E5-2640v3 and C610 chipset with on-board AHCI controller running Microsoft Windows® 2012 R2 DC. System variations, such as using the Intel RST driver, might affect measured results.

MB/s = 1,000,000 bytes/second.

www.Seagate.com Specifications

2.3 Power Consumption

The 2.5" drive receives DC power (+5 V) through the standard SATA 6.0Gb/s interface.

Table 4 Power Consumption

5 V Supply	240 GB	480 GB	960 GB	1920 GB
Operating Voltage range	5 V ± 5%	5 V ± 5%	5 V ± 5%	5 V ±5%
Inrush Current	0.91 A	1.10 A	1.20 A	1.60 A

2.3.1 Operating Power Environmental Conditions

Table 5 Operating Power

	240 GB	480 GB	960 GB	1920 GB
Active Read – Average	2.0 W	2.1 W	2.2 W	2.4 W
Active Write – Average	2.9 W	3.9 W	4.7 W	4.8 w
Active Read – Burst 500 μS Average	2.2 W	2.2 W	2.3 W	2.4 w
Active Write – Burst 500 μS Average	3.1 W	4.7 W	7.4 W	7.4 W
Idle	0.6 W	0.6 W	0.7 W	0.7 W

Table 6 Temperature, Humidity, Shock

Specification	Nytro XF1230
Temperature	
Operating (case temperature at specific airflow)	0°C to 70°C
Non-Operating	- 40°C to 95°C
Humidity	
Operating and Non-Operating	5 to 95%
Shock	
Operating and Non-Operating	1500 G at 0.5 ms

NOTE

Operating, as measured by temperature sensor, SMART Attribute ID 194.

- Measured without condensation.
- The Shock specification assumes that the SSD is mounted securely with the input vibration applied to the drive mounting. Stimulus may be applied in the X, Y or Z axis.
- These specifications do not cover connection issues that may result from testing at this level.
- Operating Shock: The drive, as installed for normal operation, operates error-free while subjected to intermittent shock not exceeding specification. Shock may be applied in the X, Y, or Z-axis. Shock must not be repeated more than once every 2 seconds.

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 Non-Operating Shock: The limits of non-operating shock applies to all conditions of handling and transportation. This includes isolated and integrated drives. Shock may be applied in the X, Y, or Z-axis.

Table 7 Vibration

Specification	Nytro XF1230
Maximum Vibrations	
Operating	3.08 Grms (7-800 Hz)
Non-Operating	16.3 Grms (20-2000 Hz)

NOTE

The Vibration specification assumes that the SSD is mounted securely with the input Vibration applied to the drive mounting screws. Stimulus may be applied in the X, Y or Z axis. This specification does not cover connection issues that may result from testing at this level

- Operating Vibration: The drive, as installed for normal operation, shall operate error free while subjected to specified vibration not exceeding specification. Vibration may be applied in the X, Y, or Z-axis.
- Non-Operating Vibration: The limits of non-operating vibration shall apply to all conditions of handling and transportation. This includes both isolated drive and integrated drives. Vibration may be applied in the X, Y, or Z-axis.

2.4 Reliability

Table 8 Reliability

Specification	Nytro XF1230		
Mean time between failures (MTBF)	2 million hours		
Bit Error Rate	1 error in 10 ¹⁷ bits transferred (exponential)		

2.5 Endurance

Table 9 Endurance

Specification	240 GB	480 GB	960 GB	1920 GB
Endurance Rating	0.5 DWPD	0.6 DWPD	0.6 7 DWPD	0.67 DWPD

NOTE

SSD Endurance is lifetime on finite amount of writes. According to JEDEC JESD218 Calculation for SSD endurance rating.

DWPD is drive write per day.

Limited Warranty with Media Usage provides coverage for the warranty period or the endurance usage of the drive.

www.Seagate.com Mechanical Information

3. Mechanical Information

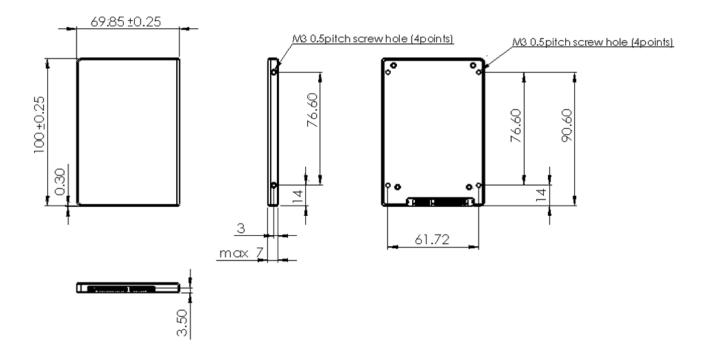
3.1 Dimensions and Weight

Weight: 0.187 lbs, 85 g **Height:** Maximum 7 mm

Width: 69.85±0.25 Length: 100±0.25

NOTE All dimensions are in millimeters.

Figure 1 Nytro XF1230 Dimensions

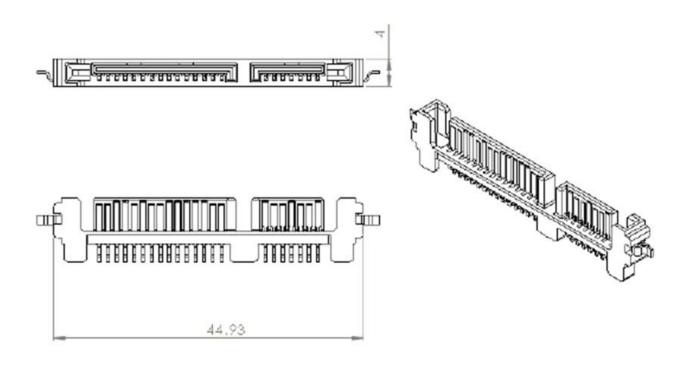


Pin and Signal Descriptions

4. Pin and Signal Descriptions

4.1 Serial ATA Interface Connector

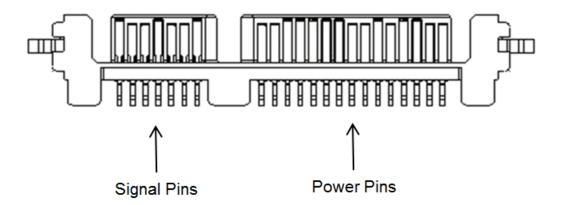
Figure 2 Connector Physical Dimension and Connector Assembly



www.Seagate.com Pin and Signal Descriptions

4.2 Pin Locations

Figure 3 Layout of 2.5-inch Signal and Power Segment Pins



NOTE The 2.5-inch connector supports built in latching capability.

4.3 Connector Pin Signal Definitions

Table 10 Serial ATA Connector Pin Signal Definitions—2.5-inch Form Factors

Pin	Name	Definition
S1	Ground	Ground
S2	A+	
S3	A-	Differential signal pair A and A-
S4	Ground	Ground
S5	B-	
S6	B+	Differential signal pair B and B-
S7	Ground	Ground

■ Key and spacing separate the signal and power segments.

Pin and Signal Descriptions

4.4 Power Pin Signal Definitions

Table 11 Serial ATA Power Pin Signal Definitions—2.5-inch Form Factors

Pin	Function	Definition
P1	V33	3.3 V Power; not used
P2	V33	3.3 V Power; not used
P3	V33	3.3 V Power; not used
P4	GND	Ground
P5	GND	Ground
P6	GND	Ground
P7	V5	5 V Power
P8	V5	5 V Power
P9	V5	5 V Power
P10	GND	Ground
P11	DAS	Device Activity Signal
P12	GND	Ground
P13	V12	12 V Power; not used
P14	V12	12 V Power; not used
P15	V12	12 V Power; not used

NOTE

Key and spacing separate the signal and power segments.

- Uses 5 V power only, 3.3 V (P1-P3) and 12 V (P13-P15) power are not used.
- Pins P1, P2, and P3; Pins P13, P14, and P15 are connected together. They are not connected internally to the device, and the host may apply voltage on these pins.
- Ground pins are P4, P5, P6, P10, P12.
- Signal pins and the rest of the 5V power pins are P8,P9.
- Power pins P7, P8, and P9 are internally connected to one another within the device

4.5 SSD Activity LED Indicator (Optional)

The Nytro XF1230 can support DAS Control function from the SSD module to indicate LED activity of host side.

The device includes a physical pin P11 for connecting device activity LEDs.

The signal provided to indicate activity of the device is a low-voltage and low-current driver intended for efficient integration into current and future IC manufacturing processes. The signal is not suitable for directly driving an LED and is first buffered using a circuit external to the device before driving an LED.

For DAS function operation, a Firmware function feature and R das are included as an option.

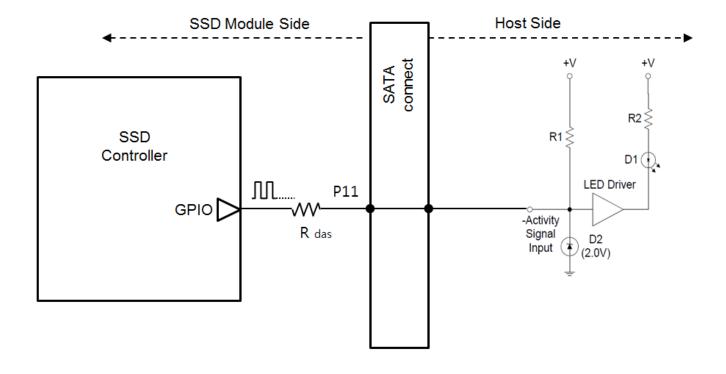
The DAS function firmware feature generates a Low/High toggle Activity signal input when the SSD is in a busy state and generates a high Activity signal input when the SSD is in idle mode (Low level: GND, High level: 3.3V).

Using DAS function increases current because of the Activity LED operation.

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The DAS Firmware feature is disabled and the R das is opened when the DAS function is not in use.

Figure 4 Circuit of SSD Activity LED indication



5. Supported ATA Command List

The Nytro XF1230 complies with ATA-8/ACS-4. All mandatory and many optional commands and features are supported.

5.1 ATA Feature Set

The following table shows the ATA feature set and commands that the Nytro XF1230 supports.

Table 12 ATA Feature Set

Feature	Supported
48-Bit Address feature set	Yes
General feature set	Yes
Native Command Queuing (NCQ) feature set	Yes
Power Management feature set	Yes
Security feature set	Yes
S.M.A.R.T feature set	Yes

5.2 ATA Command Description

The following table shows the ATA commands supported.

Table 13 ATA Command Description

Command	Code (Hex)	Command	Code (Hex)
CHECK POWER MODE	E5h	SMART DISABLE OPERATION	B0h/D9h
DATA SET MANAGEMENT	06h	SMART ENABLE/DISABLE	B0h/D2h
DOWNLOAD MICROCODE	92h	SMART ENABLE OPERATION	B0h/D8h
EXECUTE DEVICE DIAGNOSTIC	90h	SMART EXECUTE OFFLINE	B0h/D4h
FLUSH CACHE	E7h	SMART READ DATA	B0h/D0h
FLUSH CACHE EXT	EAh	SMART READ LOG	B0h/D5h
IDENTIFY DEVICE	ECh	SMART READ THRESHOLD	B0h/D1h
IDLE	E3h	SMART RETURN STATUS	B0h/DAh
IDLE IMMEDIATE	E1h	SMART SAVE ATB VALUES	B0h/D3h
INITIALIZE DEVICE PARAMETERS	91h	SMART WRITE LOG	B0h/D6h
NOP	00h	STANDBY	E2h
READ BUFFER	E4h	STANDBY IMMEDIATE	E0h
READ DMA	C8h	WRITE BUFFER	E8h
READ DMA EXT	25h	WRITE DMA	CAh
READ DMA W/O RETRIES	C9h	WRITE DMA EXT	35h
READ FPDMA QUEUED	60h	WRITE DMA FUA EXT	3Dh
READ LOG DMA EXT	47h	WRITE DMA WITHOUT RETRIES	CBh
READ LOG EXT	2Fh	WRITE FPDMA QUEUED	61h
READ MULTIPLE	C4h	WRITE LOG DMA EXT	57h
READ MULTIPLE EXT	29h	WRITE LOG EXT	3Fh

Table 13 ATA Command Description (continued)

Command	Code (Hex)	Command	Code (Hex)
READ SECTOR(S)	20h	WRITE MULTIPLE	C5h
READ SECTOR(S) EXT	24h	WRITE MULTIPLE EXT	39h
READ SECTOR(S) W/O RETRY	21h	WRITE MULTIPLE FUA EXT	CEh
READ VERIFY SECTOR(S)	40h	WRITE SECTOR(S)	30h
READ VERIFY SECTOR(S) W/O RETRY	41h	WRITE SECTOR(S) EXT	34h
READ VERIFY SECTOR(S) EXT	42h	WRITE SECTORS WITHOUT RETRY	31h
RECALIBRATE	10h	WRITE UNCORRECTABLE EXT	45h
REQUEST SENSE DATA EXT	0Bh		
SECURITY DISABLE PASSWORD	F6h		
SECURITY ERASE PREPARE	F3h		
SECURITY ERASE UNIT	F4h		
SECURITY FREEZE LOCK	F5h		
SECURITY SET PASSWORD	F1h		
SECURITY UNLOCK	F2h		
SEEK	70h		
SET FEATURES	EFh		
SET MULTIPLE MODE	C6h		
SLEEP	E6h		

5.2.1 Security

The user/master password is supported.

When the device receives a normal SECURITY ERASE UNIT command, the device erases all data blocks including unallocated (hidden) blocks.

You can download firmware regardless of the security state.

5.2.1.1 Password Loss

If you lose the user password, you can access the device using the master password. If both passwords are lost, there is no way to access the device. You can reset the device, and you can use it like a fresh drive but the old data is lost.

www.Seagate.com SMART Support

6. SMART Support

The Nytro XF1230 supports the S.M.A.R.T(Self-Monitoring, Analysis, and Reporting Technology) Command Set.

6.1 SMART Command Set

The Nytro XF1230 supports the SMART Command Set shown in the following table.

Table 14 SMART Attributes

Feature Field Values	Command
D0h	SMART READ DATA
D1h	SMART READ ATTRIBUTE THRESHOLDS
D2h	SMART ENABLE/DISABLE ATTRIBUTE AUTOSAVE
D3h	SAVE ATTRIVUTE VALUES
D4h	SMART EXECUTE OFF-LINE IMMEDIATE
00h*	Execute SMART Off-Line routine
01h*	Execute SMART Short Self-test routine (Off-Line)
02h*	Execute SMART Extended Self-test routine (Off-Line)
03h*	Execute SMART Conveyance self-test routine in off-line mode
04h*	Execute SMART Selective self-test routine in off-line mode
7Fh*	Abort Off-Line routine
81h*	Execute SMART Short Self-test routine (Captive)
82h*	Execute SMART Extended Self-test routine (Captive)
83h*	Execute SMART Conveyance self-test routine in captive mode
84h*	Execute SMART Selective self-test routine in captive mode
D5h	SMART READ LOG
D6h	SMART WRITE LOG
D8h	SMART ENABLE OPERATIONS
D9h	SMART DISABLE OPERATIONS
DAh	SMART RETURN STATUS
*Low LBA values	1

6.2 SMART Attributes

The Nytro XF1230 supports the SMART attributes shown in the following table.

Table 15 SMART Attributes

ID	Attribute ID	Description
1	Raw Read Error Rate	Rate of hardware read errors that occurred when reading data from a device
5	Retired Block count	Count of number of blocks that have been reallocated, excluding pending sectors
9	Power on hours	The time accumulated while the power is on and operating
12	Drive Power cycle count	Count of number of Power Cycles, excluding power modecommands
171	Program Fail Count	Number of Error Events on Program

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Table 15 SMART Attributes (continued)

ID	Attribute ID	Description		
172	Erase Fail Count	Number of Error Events on Erase		
174	Unexpected Power Loss Count	Number of Issue on Unexpected Power Loss		
175	Maximum Program Fail Count	Maximum number of Program Error Events per die		
176	Maximum Erase Fail Count	Maximum number of Erase Error Events per die		
177	Endurance Used	Indicates the number of NAND wear		
178	Used Reserved Block Count	Number of used reserved blocks		
179	Used Reserved Block Count	Number of used reserved blocks in SSD		
180	End to End Error Detection Rate	Number of error detections of the data path between host and NAND in SSD during last power-on		
181	Program Fail Count	Number of Error Events on Program (Lifetime)		
182	Erase Fail Count	Number of Error Events on Erase (Lifetime)		
183	SATA Downshift Count	Number of times that SATA interface speed reduced		
184	End to End Error Detection Count	Number of error detection of the data path between host and NAND in SSD lifetime		
187	Uncorrectable Error Count	Uncorrectable Error Count		
188	Command Timeout Count	Number of total uncompleted commands		
194	Temperature (Celsius)	Temperature of the SSD		
195	ECC Uncorrectable Error Rate	Uncorrectable Error Count vs. Total read sector count		
197	Current Pending Sector Count	Number of unstable sectors which will be remapped on nextwrite		
201	Uncorrectable Soft Read Error Rate (UECC)	Number of soft read errors (Count of UECC Error)		
204	Soft ECC Correction Rate	Count of errors corrected by software ECC [citation needed]		
231	SSD Life Left (%)	Indicates the approximate SSD life left, in terms of program/erase cycles or Flash blocks currently available for use		
234	Vendor Specific	Information of Vendor		
241	Total LBAs Written	The total number of 512-byte sectors written during the entire lifetime of the device.		
242	Total LBAs Read	The total number of 512-byte sectors read during the entire lifetime of the device.		
250	Read Error Retry Rate	There is no reliable information available about this attribute.		

6.3 SMART Trip

SMART trip (threshold exceeded condition) indicates impending degradation or fault condition. The host can issue a SMART return status command (B0h/DAh) to communicate the reliability status of the drive. The threshold-exceeded condition is also checked during drive self tests.

7. Safety, Standards, and Compliance

7.1 Safety Characteristics

All Seagate SSDs meet or exceed the requirements of UL flammability rating 94V-0. Each bare board is marked with the supplier's name or trademark, type, and UL flammability rating. A CB and UL report has been generated for EN60950.

7.2 Electromagnetic Compliance and Standards

The Nytro XF1230 card is designed to minimize electromagnetic emissions, susceptibility to radio frequency energy, and the effects of electrostatic discharge. The card carries the CE mark, RCM, Canadian Compliance Statement, KCC, Taiwan BSMI, Japan VCCI, and FCC Class B, and the card is marked with the FCC Self-Certification logo. The card also meets the requirements of CISPR Class B.

7.3 Standards

The Nytro XF1230 card is recognized in accordance with UL 60950-1 as tested by UL, CAN/CSA C22.2 No. 60950-1 and IEC/EN60950-1 as tested by TUV SUD.

7.4 Electromagnetic Compatibility



Electromagnetic Compatibility Notices

CE

Electromagnetic Compatibility Notices

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

- This device may not cause harmful interference, and
- This device must accept any interference received, including interference that may cause undesired operation.

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and the receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

Shielded cables for SCSI connection external to the cabinet are used in the compliance testing of this Product. Seagate is not responsible for any radio or television interference caused by unauthorized modification of this equipment or the substitution or attachment of connecting cables and equipment other than those specified by Seagate Technology LLC. The correction of interferences caused by such unauthorized modification, substitution, or attachment will be the responsibility of the user. The device is tested to comply with FCC standards for home or office use.

This Class B digital apparatus meets all requirements of the Canadian Interference-Causing Equipment Regulations. Cet appareil numérique de la classe B respecte toutes les exigences du Règlement sur le matériel brouilleur du Canada.

7.5 Electromagnetic Compliance

Seagate uses an independent laboratory to confirm compliance with the directives/standards for CE Marking and C-Tick Marking. The Nytro XF1230 card was tested in a representative system for typical applications and complies with the Electromagnetic Interference/Electromagnetic Susceptibility (EMI/EMS) for Class B products. The selected system represents the most popular characteristics for test platforms. The system configurations include:

- Typical current-use microprocessor
- Keyboard
- Monitor display
- Printer
- Mouse

Although the test system with this Seagate model complies with the directives and standards, we cannot guarantee that all systems comply. The computer or server manufacturer or the system integrator must confirm EMC compliance and provide the appropriate marking for their product.

7.6 Electromagnetic Compliance for the European Union

If this model has the CE Marking it complies with the European Union requirements of the Electromagnetic Compatibility Directive 2004/108/EC as put into place on 20 July 2007.

7.7 Australian RCM

If this model has the RCM Marking it complies with the Australia/New Zealand Standard AS/NZ CISPR22 and meets the Electromagnetic Compatibility (EMC) Framework requirements of Australia's Spectrum Management Agency (SMA).

7.8 Korean KCC

If this model has the Korean Communications Commission (KCC) logo, it complies with KN22, KN 24, and KN61000.

7.9 Taiwanese BSMI

If this model has the Taiwanese certification mark then it complies with Chinese National Standard, CNS13438.

7.10 Japan VCCI

この装置は、情報処理装置等電波障害自主規制協議会(VCCI)の基準に基づくクラス B 情報技術装置です。この装置は、家庭環境で使用することを目的としていますが、この装置がラジオやテレビジョン受信機に近接して使用されると、受信障害を引き起こすことがあります。

取扱説明書に従って正しい取り扱いをして下さい。

This is a Class B product based on the standard of the Voluntary Control Council for Interference from Information Technology Equipment (VCCI). If this is used near a radio or television receiver in a domestic environment, it may cause radio interference. Install and use the equipment according to the instruction guide.

7.11 China Restriction of Hazardous Substances (RoHS)

Directive 中国限制危险物品的指令

This product has an Environmental Protection Use Period (EPUP) of 20 years. The following table contains information mandated by China's "Marking Requirements for Control of Pollution Caused by Electronic Information Products" Standard.



该产品具有20年的环境保护使用周期 (EPUP)。 下表包含了中国 "电子产品所导致的污染的控制的记号要求"所指定的信息。

Toxic or Hazardous Substances or E				lements 有毒有害物质或元素		
Name of Parts 部件名称	Lead 铅 (Pb)	Mercury 汞 (Hg)	Cadmium 镉 (Cd)	Hexavalent Chromium 六价铬 (Cr6+)	Polybrominated Diphenyl 多溴联苯 (PBB)	Polybrominated Diphenyl Ether 多溴二苯醚 (PBDE)
PCBA	X	0	0	0	0	0
Chassis	X	0	0	0	0	0

"O" indicates the hazardous and toxic substance content of the part (at the homogeneous material level) is lower than the threshold defined by the China RoHS MCV Standard.

"O"表示该部件(于同类物品程度上)所含的危险和有毒物质低于中国RoHS MCV标准所定义的门槛值。

"X" indicates the hazardous and toxic substance content of the part (at the homogeneous material level) is over the threshold defined by the China RoHS MCV Standard.

"X"表示该部件(于同类物品程度上)所含的危险和有毒物质超出中国RoHS MCV标准所定义的门槛值。

7.11.1 Reference Documents

In case of conflict between this document and any reference document, this document takes precedence.

Table 16 Reference Documents

	Name
Apr. 2007	SATA-IO Commands for ATA-8
Feb. 2011	Solid-State Drive (SSD) Requirements and Endurance Test Method(JESD218A)
Jul. 2011	Serial ATA Revision 3.1
Jul. 2011	IDEMA (LBA1-03_standard.doc)
Jul. 2012	SOLID-STATE DRIVE (SSD) Endurance Workload (JESD219A)
Jul. 2015	ATA/ATAPI Command Set -4 (ACS-4) Working Draft
Nov. 2011	ISO/IEC 14776-xxxSCSI Block Commands-3 (SBC-3) Standard (T10/1799-D)



Seagate Technology LLC

AMERICAS Seagate Technology LLC 10200 South De Anza Boulevard, Cupertino, California 95014, United States, 408-658-1000
ASIA/PACIFIC Seagate Singapore International Headquarters Pte. Ltd. 7000 Ang Mo Kio Avenue 5, Singapore 569877, 65-6485-3888
EUROPE, MIDDLE EAST AND AFRICA Seagate Technology SAS 16-18 rue du Dôme, 92100 Boulogne-Billancourt, France, 33 1-4186 10 00

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